



**Section** \_\_\_\_\_

MV Semi-conductor

**Application** \_\_\_\_\_

Field  
Production



### PRODUCT BENEFITS

4 adjustable scoring depth  
Easy catch of the semicon  
Light

### TOOL CAPACITY

<b>Diameter</b>	10 - 100 mm 0,394 - 3,937 inch
<b>Scoring depth</b>	0.4 / 0.6 / 0.9 / 1.1 mm 0.016 / 0.024 / 0.035 / 0.043 inch
<b>Min remaining length</b>	10 mm

### TOOL DIMENSIONS

<b>Length</b>	135 mm
<b>Width</b>	55 mm
<b>Height</b>	35 mm
<b>Weight without box</b>	0,16 Kg
<b>Packaging</b>	Box

## Tool to perform controlled longitudinal scoring on peelable semiconductor

### TO DO WHAT

The ORACL enables the user to score longitudinally the peelable semiconductive layer in order to peel it off by hand.  
Adjustable scoring depths (0.4 / 0.6 / 0.9 / 1.1 mm)



### Spare part

LSO - Spare blade for peelable semiconductor

### Associated tool

DSP - Peelable semiconductor lifter  
MVS - Stop for tools



MV cables Tools

# ORACL



Part Number	Diameter	Tool capacity		Dimensions			Packaging
		Scoring depth	Min remaining length	Length	Width	Height	
ORACL	10 - 100 mm 0,394 - 3,937 in	0.4 / 0.6 / 0.9 / 1.1 mm 0.016 / 0.024 / 0.035 / 0.043 inch	10 mm	135 mm 5,315 in	55 mm 2,165 in	35 mm 1,378 in	box



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